



RE200-HT

- High-temperature printed circuit board
- Polyimide resin based fibre-glass P97 1.50 mm
- Single-sided 35 µm Cu
- Surface chem. Ni/Au
- Hole spacing 2.54 x 2.54 mm
- 38 x 61 soldering pads 2.20 mm Ø
- Hole diameter 1.00 mm
- Suitable for temperature ranges up to 260 °C
- Size 100 x 160 mm